

# GS74LVC1G32 Series

## Single 2-Input OR Gate

### Product Description

The GS74LVC1G32 is designed for 1.65V to 5.5V  $V_{CC}$  operation, performs the Boolean function  $Y=A+B$ .

Inputs can be driven from either 3.3V or 5V devices. These features allow the use of these devices in a mixed 3.3V and 5V system environment.

Schmitt trigger action at all inputs makes the circuit tolerant for slower input rise and fall time.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing damaging backflow current through the device when it is powered down.

### Features

- Supports 1.65V to 5.5V  $V_{CC}$  operation
- $\pm 24\text{mA}$  output drive at  $V_{CC}=3.0\text{V}$
- CMOS low power consumption
- Direct interface with TTL levels
- Input accepts voltages up to 5V
- Latch-up performance exceeds 100mA
- RoHS Compliant and Halogen Free

### Packages & Pin Assignments

GS74LVC1G32LF (SOT-23-5L)			GS74LVC1G32JCF (SOT-353)		
Pin	Pin Name	I/O	Description		
1	B	I	Data Input		
2	A	I	Data Input		
3	GND	--	Ground (0V)		
4	Y	O	Data Output		
5	$V_{CC}$	--	Supply Voltage		

## Functional Block Diagram and Description

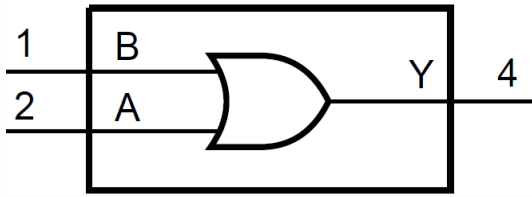


Fig 1. Function Diagram

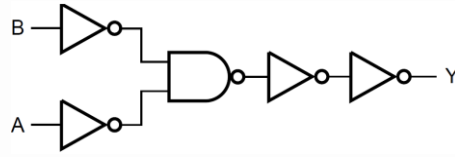


Fig 2. Logic Diagram

Input A	Input B	Output Y
L	L	L
L	H	H
H	L	H
H	H	H

H = HIGH Voltage Level  
L = LOW Voltage Level.

## Ordering and Marking Information

Ordering Information			
Part Number	Package	Part Marking	Quantity / Reel
GS74LVC1G32LF	SOT-23-5L	G32□□	3,000 PCS
GS74LVC1G32JCF	SOT-353	G32□□	3,000 PCS

<b>GS74LVC1G32</b> <span style="border: 1px solid black; padding: 0 2px;">1</span> <span style="border: 1px solid black; padding: 0 2px;">2</span>		
<b>- Product</b> GS74LVC1G32	<b>- Package Code:</b> - <span style="border: 1px solid black; padding: 0 2px;">1</span> is L and JC L is SOT-23-5L JC is SOT-353	<b>- Green Level:</b> <span style="border: 1px solid black; padding: 0 2px;">2</span> is F for RoHS Compliant and Halogen Free

Marking Information	
	<b>- Product Code:</b> G32  <b>- GS Code:</b> □ □

## Absolute Maximum Ratings (T<sub>A</sub>=25°C Unless Otherwise Noted)

Characteristics	Symbol	Conditions	Min.	Max.	Unit
Supply Voltage	V <sub>CC</sub>	--	-0.5	+6.5	V
Input Voltage	V <sub>I</sub>	[1]	-0.5	+6.5	V
Input Clamping Current	I <sub>IK</sub>	V <sub>I</sub> < 0V	-50	--	mA
Output Clamping Current	I <sub>OK</sub>	V <sub>O</sub> < 0V or V <sub>O</sub> > V <sub>CC</sub>	-50	+50	mA
Output Voltage	V <sub>O</sub>	Active mode [1]	-0.5	V <sub>CC</sub> +0.5	V
		Power-down mode [1]	-0.5	+6.5	V
Output Current	I <sub>O</sub>	V <sub>O</sub> =0V to V <sub>CC</sub>	-50	+50	mA
Supply Current	I <sub>CC</sub>	--	--	+100	mA
Ground Current	I <sub>GND</sub>	--	-100	--	mA
Storage Temperature	T <sub>stg</sub>	--	-65	+150	°C
Thermal Resistance, Junction to Ambient	R <sub>thJA</sub>	--	--	239	°C/W
Latch up	LU	T <sub>A</sub> =25°C, 125°C	100	--	mA

### NOTE

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed

## Recommended Operating Condition (unless otherwise specified, T<sub>A</sub>=25°C)

(Voltages are referenced to GND (ground=0V))

Characteristics	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage	V <sub>CC</sub>	--	1.65	--	5.5	V
Input Voltage	V <sub>I</sub>	--	0	--	5.5	V
Output Voltage	V <sub>O</sub>	--	0	--	V <sub>CC</sub>	V
Ambient Temperature	T <sub>A</sub>	--	-40	+25	+125	°C
Input Transition Rise and Fall Rate	Δt/ΔV	V <sub>CC</sub> =1.65V to 2.7V	--	--	20	ns/V
		V <sub>CC</sub> =2.7V to 5.5V	--	--	10	ns/V

## Electrical Characteristics

### ■ Static Characteristics (Voltages are referenced to GND (ground=0V))

Characteristics	Symbol	Test condition	-40°C to 85°C			-40°C to +125°C		Unit
			Min.	Typ. <sup>[1]</sup>	Max.	Min.	Max.	
High-level input voltage	V <sub>IH</sub>	V <sub>CC</sub> =1.65V to 1.95V	0.65 V <sub>CC</sub>	--	--	0.65 V <sub>CC</sub>	--	V
		V <sub>CC</sub> =2.3V to 2.7V	1.7	--	--	1.7	--	V
		V <sub>CC</sub> =2.7V to 3.6V	2.0	--	--	2.0	--	V
		V <sub>CC</sub> =4.5V to 5.5V	0.7 V <sub>CC</sub>	--	--	0.7 V <sub>CC</sub>	--	V
Low-level input voltage	V <sub>IL</sub>	V <sub>CC</sub> =1.65V to 1.95V	--	--	0.35 V <sub>CC</sub>	--	0.35 V <sub>CC</sub>	V
		V <sub>CC</sub> =2.3V to 2.7V	--	--	0.7	--	0.7	V
		V <sub>CC</sub> =2.7V to 3.6V	--	--	0.8	--	0.8	V
		V <sub>CC</sub> =4.5V to 5.5V	--	--	0.3 V <sub>CC</sub>	--	0.3 V <sub>CC</sub>	V
High-level output voltage	V <sub>OH</sub>	V <sub>I</sub> =V <sub>IH</sub> or V <sub>IL</sub>						
		I <sub>O</sub> =-100μA; V <sub>CC</sub> =1.65V to 5.5V	V <sub>CC</sub> -0.1	--	--	V <sub>CC</sub> -0.1	--	V
		I <sub>O</sub> =-4mA; V <sub>CC</sub> =1.65V	1.2	--	--	0.95	--	V
		I <sub>O</sub> =-8mA; V <sub>CC</sub> =2.3V	1.9	--	--	1.7	--	V
		I <sub>O</sub> =-12mA; V <sub>CC</sub> =2.7V	2.2	--	--	1.9	--	V
		I <sub>O</sub> =-24mA; V <sub>CC</sub> =3.0V	2.3	--	--	2.0	--	V
		I <sub>O</sub> =-32mA; V <sub>CC</sub> =4.5V	3.8	--	--	3.4	--	V
Low-level output voltage	V <sub>OL</sub>	V <sub>I</sub> =V <sub>IH</sub> or V <sub>IL</sub>						
		I <sub>O</sub> =100μA; V <sub>CC</sub> =1.65V to 5.5V	--	--	0.1	--	0.1	V
		I <sub>O</sub> =4mA; V <sub>CC</sub> =1.65V	--	--	0.45	--	0.7	V
		I <sub>O</sub> =8mA; V <sub>CC</sub> =2.3V	--	--	0.30	--	0.45	V
		I <sub>O</sub> =12mA; V <sub>CC</sub> =2.7V	--	--	0.40	--	0.60	V
		I <sub>O</sub> =24mA; V <sub>CC</sub> =3.0V	--	--	0.55	--	0.80	V
		I <sub>O</sub> =32mA; V <sub>CC</sub> =4.5V	--	--	0.55	--	0.80	V
Input leakage current	I <sub>I</sub>	V <sub>I</sub> =5.5V or GND; V <sub>CC</sub> =0V to 5.5V	--	±0.1	±1.0	--	±1.0	μA
Power-off leakage current	I <sub>OFF</sub>	V <sub>CC</sub> =0V; V <sub>I</sub> or V <sub>O</sub> =5.5V	--	±0.1	±2.0	--	±2.0	μA
Supply current	I <sub>CC</sub>	V <sub>I</sub> =5.5V or GND; I <sub>O</sub> =0A; V <sub>CC</sub> =1.65V to 5.5V	--	0.1	4.0	--	4.0	μA
Additional supply current	ΔI <sub>CC</sub>	V <sub>CC</sub> =2.3V to 5.5V V <sub>I</sub> =V <sub>CC</sub> -0.6V; I <sub>O</sub> =0A; Per input pin;	--	5	500	--	500	μA
Input capacitance	C <sub>I</sub>	--	--	8	--	--	--	pF

#### NOTE

1. Typical values are measured at V<sub>CC</sub>=3.3V and T<sub>A</sub>=25°C.

## Electrical Characteristics

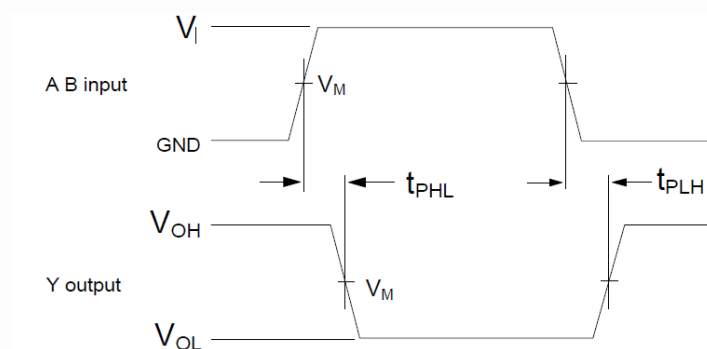
### ■ Dynamic Characteristics (GND=0V. for test circuit see Fig.4)

Characteristics	Symbol	Test condition	-40°C to 85°C			-40°C to +125°C		Unit
			Min.	Typ. <sup>[1]</sup>	Max.	Min.	Max.	
Propagation delay	T <sub>PD</sub>	A, B to Y; see Fig.4 <sup>[2]</sup>						
		V <sub>CC</sub> =1.65V to 1.95V	1.0	5.2	10.8	1.0	13.2	ns
		V <sub>CC</sub> =2.3V to 2.7V	0.5	3.0	7.5	0.5	9.0	ns
		V <sub>CC</sub> =2.7V	0.5	3.5	8.4	0.5	9.8	ns
		V <sub>CC</sub> =3.0V to 3.6V	0.5	2.6	6.2	0.5	7.5	ns
		V <sub>CC</sub> =4.5V to 5.5V	0.5	2.2	5.4	0.5	6.3	ns

#### NOTE

1. Typical values are measured at T<sub>A</sub>=25°C, V<sub>CC</sub> = 1.8V, 2.5V, 3.3V and 5.0 V respectively.
2. t<sub>PD</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

## Waveforms And Test Circuit

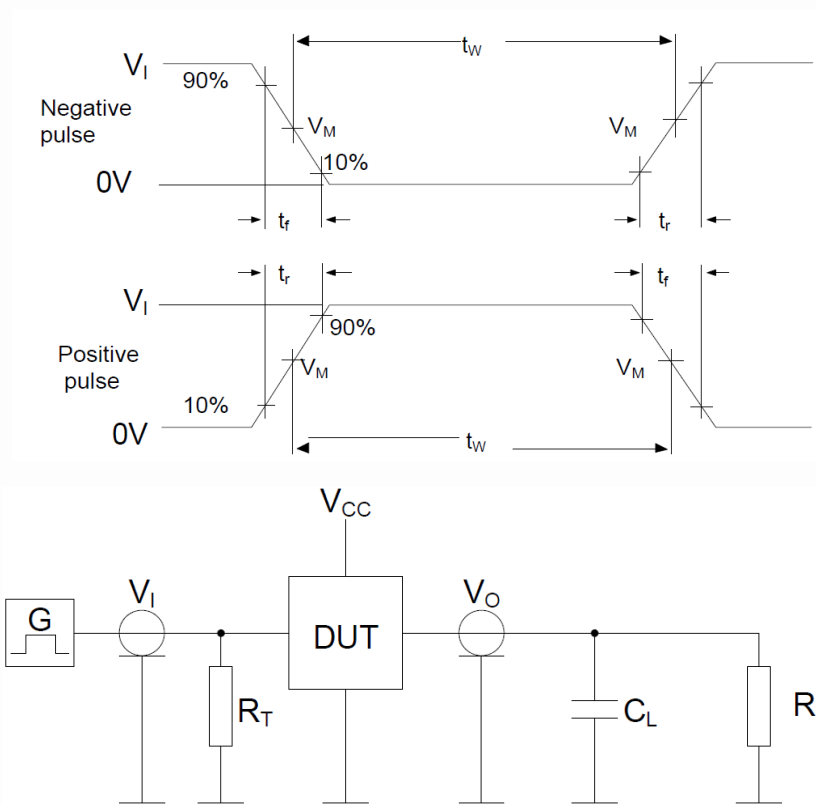


V<sub>OL</sub> and V<sub>OH</sub> are typical voltage output levels that occur with the output load.

Fig 3. Propagation delay input (A, B) to output (Y)

### ■ Measurement points

Supply voltage	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
1.65V to 1.95V	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>
2.3V to 2.7V	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>
2.7V	1.5V	1.5V
3.0V to 3.6V	1.5V	1.5V
4.5V to 5.5V	0.5 x V <sub>CC</sub>	0.5 x V <sub>CC</sub>



**Fig 4. Test circuit for measuring switching times**

Definitions test circuit :

$R_T$ = Termination resistance should be equal to output impedance  $Z_O$  of the pulse generator

$C_L$ = Load capacitance including jig and probe capacitance

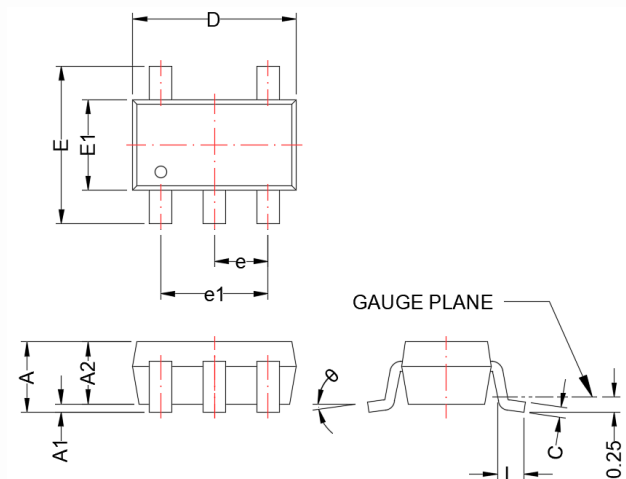
$R_L$ = Load resistor

■ **Test Data**

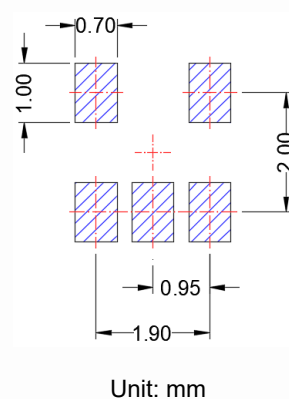
Supply voltage	Input		Load	
	$V_I$	$t_R, t_F$	$C_L$	$R_L$
1.65V to 1.95V	$V_{CC}$	$\leq 3.0ns$	30pF	1k $\Omega$
2.3V to 2.7V	$V_{CC}$	$\leq 3.0ns$	30pF	500 $\Omega$
2.7V	2.7V	$\leq 3.0ns$	50pF	500 $\Omega$
3.0V to 3.6V	2.7V	$\leq 3.0ns$	50pF	500 $\Omega$
4.5V to 5.5V	$V_{CC}$	$\leq 3.0ns$	50pF	500 $\Omega$

# SOT-23-5L

## Package Dimension



## Recommended Land Pattern

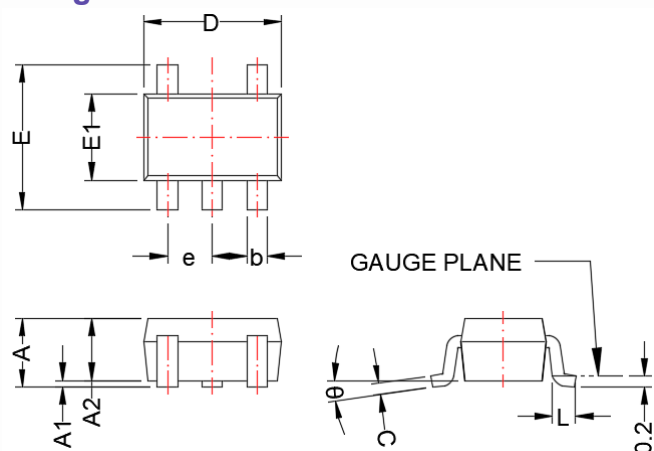


Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.90	1.45	0.035	0.057
A1	0.00	0.15	0.000	0.006
A2	0.90	1.30	0.035	0.051
b	0.30	0.50	0.012	0.020
c	0.08	0.26	0.003	0.010
D	2.70	3.10	0.106	0.122
E	2.20	3.00	0.087	0.118
E1	1.30	1.75	0.051	0.069
e	0.95 BSC		0.037 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.30	0.60	0.012	0.024
$\theta$	0°	8°	0°	8°

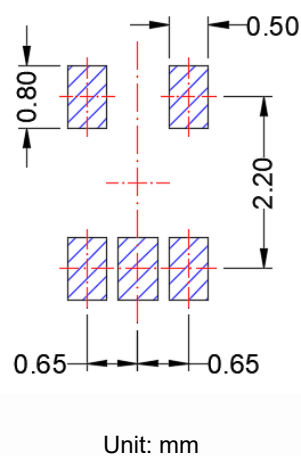
Note:  
Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

# SOT-353

## Package Dimension



## Recommended Land Pattern



Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	---	1.10	---	0.043
A1	0.00	0.10	0.000	0.004
A2	0.70	1.00	0.028	0.039
b	0.15	0.35	0.006	0.014
c	0.08	0.25	0.003	0.010
D	1.80	2.20	0.071	0.087
E	1.80	2.45	0.071	0.096
E1	1.15	1.35	0.045	0.053
e	0.65 BSC		0.026 BSC	
L	0.26	0.46	0.010	0.018
$\theta$	0°	8°	0°	8°





Note:  
Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.





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